

MBR200100CTS

Silicon Power Schottky Diode

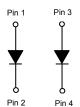
 $V_{RRM} = 100 V$ $I_F = 200 A$

Features

• High Surge Capability

Package





SOT - 227

Maximum Ratings at T_j = 125 °C, unless otherwise specified

Parameter	Symbol	Conditions	Values	Unit
Repetitive peak reverse voltage	V_{RRM}		100	V
RMS reverse voltage	V_{RMS}		70	V
DC blocking voltage	V_{DC}		100	V
Continuous forward current	l _F	T _C ≤ 85 °C	200	Α
Operating temperature	T _j		-40 to 175	°C
Storage temperature	T _{stg}		-40 to 175	°C

Electrical Characteristics at T_j = 125 °C, unless otherwise specified (Per Leg)

Parameter	Symbol	Conditions	Values		Unit	
Farameter		Conditions	min.	typ.	max.	Onit
Diada farward valtage		$I_F = 100 \text{ A}, T_j = 25 ^{\circ}\text{C}$		0.9	0.95	
Diode forward voltage	V_{F}	$I_F = 100 \text{ A}, T_j = 125 ^{\circ}\text{C}$		8.0		V
Reverse current	1	$V_R = 80 \text{ V}, T_j = 25 ^{\circ}\text{C}$		3.75	10	^
Neverse current	IR	$V_R = 80 \text{ V}, T_j = 125 ^{\circ}\text{C}$		1830	5000	μΑ
		$V_R = 1 \text{ V, f} = 1 \text{ MHz, T}_j = 25 \text{ °C}$		4960		
Total capacitance	С	$V_R = 50 \text{ V}, f = 1 \text{ MHz}, T_j = 25 ^{\circ}\text{C}$		854		pF
		$V_R = 100 \text{ V}, f = 1 \text{ MHz}, T_j = 25 ^{\circ}\text{C}$		617		

Thermal Characteristics

Thermal resistance, junction - case	R _{thJC}	1.87	°C/W

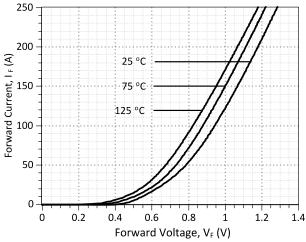


Figure 1: Typical Forward Characteristics(Per Leg)

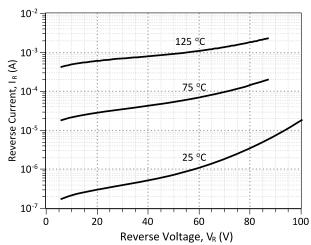


Figure 2: Typical Reverse Characteristics(Per Leg)



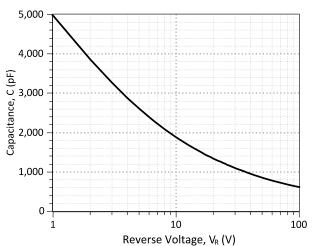
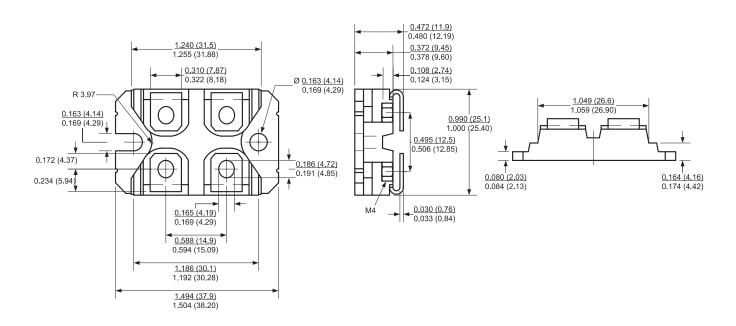


Figure 3: Typical Junction Capacitance vs Reverse Voltage Characteristics(Per Leg)

Package Dimensions:

SOT-227

PACKAGE OUTLINE



NOTE

- 1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.
- 2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS

Revision History					
Date	Revision	Comments	Supersedes		
2012/03/12	0	Initial release			

Published by GeneSiC Semiconductor, Inc. 43670 Trade Center Place Suite 155 Dulles, VA 20166

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